

### Features

- Very Low FOM  $R_{DS(on)} \times Q_g$
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Halogen Free Available Upon Request By Adding Suffix "-HF"
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

### Maximum Ratings

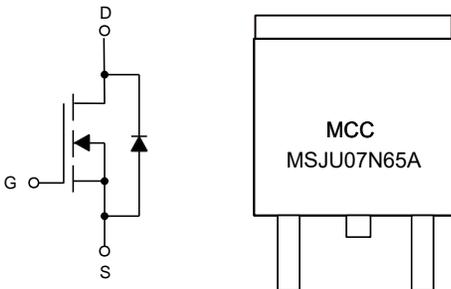
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 62°C/W Junction to Ambient
- Thermal Resistance: 2°C/W Junction to Case

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	650	V
Gate-Source Voltage	$V_{GS}$	±30	V
Continuous Drain Current	$I_D$	$T_C=25^\circ\text{C}$	7
		$T_C=100^\circ\text{C}$	4.2
Pulsed Drain Current <sup>(Note 1)</sup>	$I_{DM}$	21	A
Single Pulse Avalanche Energy <sup>(Note 2)</sup>	$E_{AS}$	142	mJ
Total Power Dissipation	$P_D$	63	W

Note:

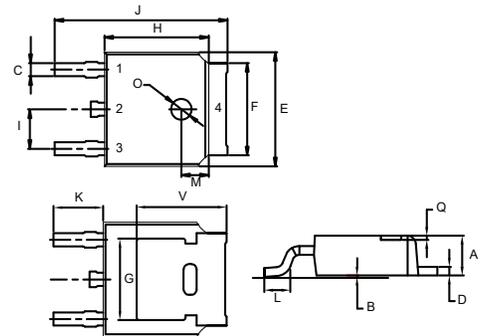
1. Repetitive Rating; Pulse Width Limited by Maximum Junction Temperature.
2.  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .

### Internal Structure and Marking Code



## N-CHANNEL Super-Junction Power MOSFET

### DPAK(TO-252)



1. Gate
- 2,4. Drain
3. Source

DIM	DIMENSIONS				NOTE
	INCHES		MM		
	MIN	MAX	MIN	MAX	
A	0.087	0.094	2.20	2.40	
B	0.000	0.005	0.00	0.13	
C	0.026	0.034	0.66	0.86	
D	0.018	0.023	0.46	0.58	
E	0.256	0.264	6.50	6.70	
F	0.201	0.215	5.10	5.46	
G	0.190		4.83		TYP.
H	0.236	0.244	6.00	6.20	
I	0.086	0.094	2.18	2.39	
J	0.386	0.409	9.80	10.40	
K	0.114		2.90		TYP.
L	0.055	0.067	1.40	1.70	
M	0.063		1.60		TYP.
O	0.043	0.051	1.10	1.30	
Q	0.000	0.012	0.00	0.30	
V	0.211		5.35		TYP.

**Electrical Characteristics @ 25°C (Unless Otherwise Specified)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	650			V
Gate-Source Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 30V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=650V, V_{GS}=0V$			1	$\mu A$
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	3	4	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=2.5A$		0.53	0.6	$\Omega$
Gate Resistance	$R_G$	f = 1.0MHz Open Drain		21		$\Omega$
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=7A$			1.4	V
Continuous Body Diode Current	$I_S$				7	A
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V, f=1MHz$		545		pF
Output Capacitance	$C_{oss}$			640		
Reverse Transfer Capacitance	$C_{rss}$			28.6		
Total Gate Charge	$Q_g$	$V_{DD}=520V, V_{GS}=10V, I_D=7A$		13		nC
Gate-Source Charge	$Q_{gs}$			2.8		
Gate-Drain Charge	$Q_{gd}$			5.6		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=350V, I_D=7A, R_G=25\Omega$		18		ns
Turn-On Rise Time	$t_r$			33		
Turn-Off Delay Time	$t_{d(off)}$			80		
Turn-Off Fall Time	$t_f$			28		
Reverse Recovery Time	$t_{rr}$	$V_R=100V, I_F=7A, di/dt = 100A/\mu s$		271		ns
Reverse Recovery Charge	$Q_{rr}$			2.9		$\mu C$
Peak Reverse Recovery Current	$I_{rrm}$			21.2		A

## Curve Characteristics

Fig. 1 - Typical Output Characteristics

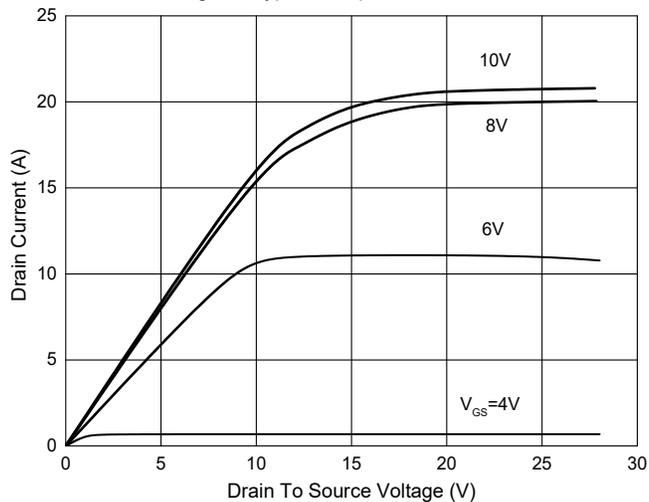


Fig. 2 - Transfer Characteristics

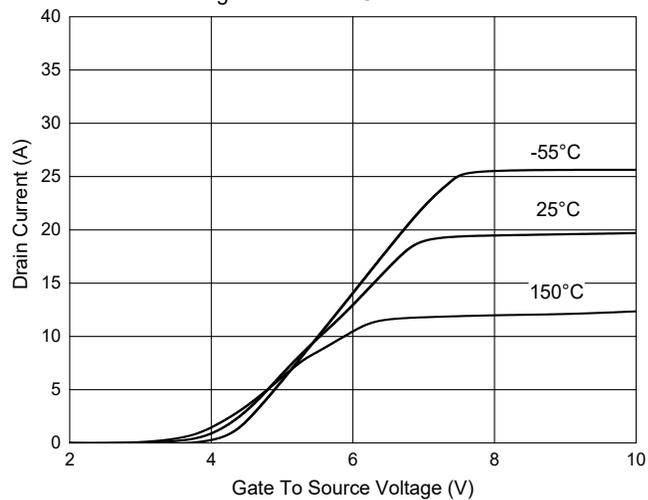


Fig. 3 -  $R_{DS(ON)}-I_D$

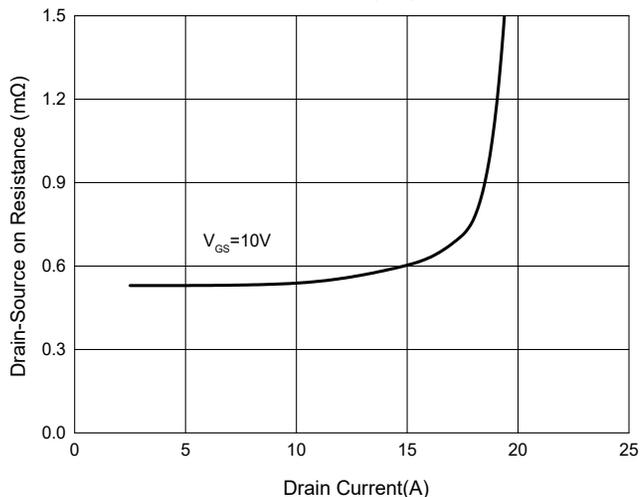


Fig. 4 - Normalized On Resistance Characteristics

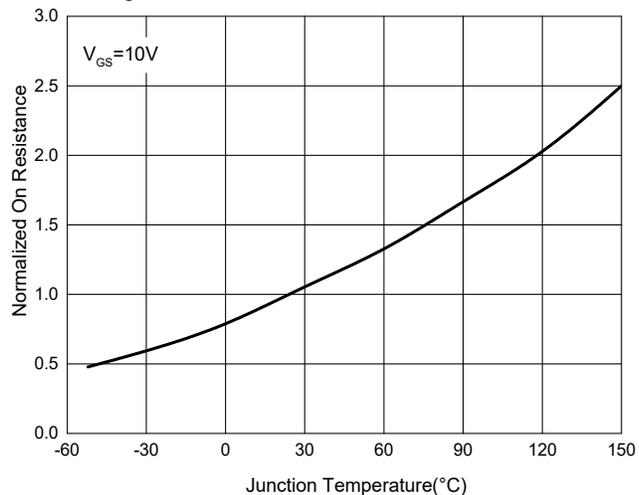


Fig. 5 - Gate Charge

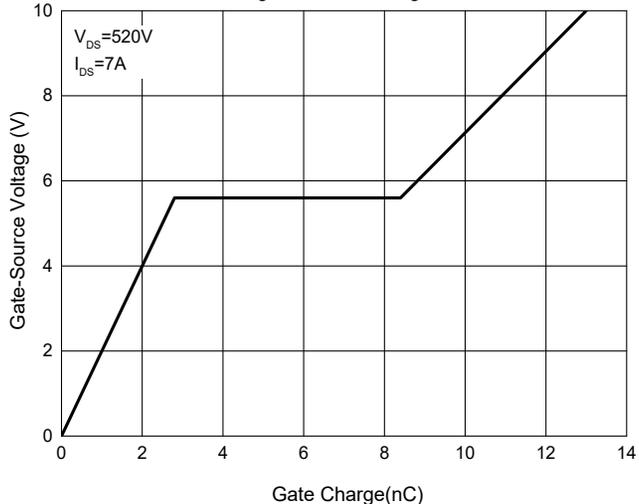


Fig. 6 - Capacitance Characteristics

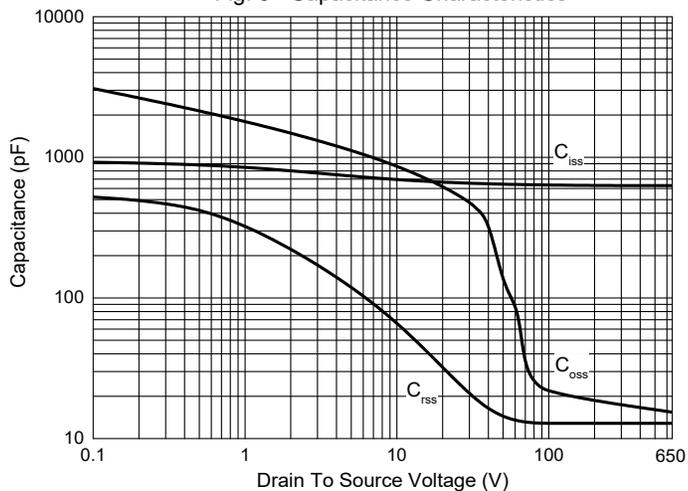


Fig. 7 - Normalized Drain-Source Breakdown Voltage

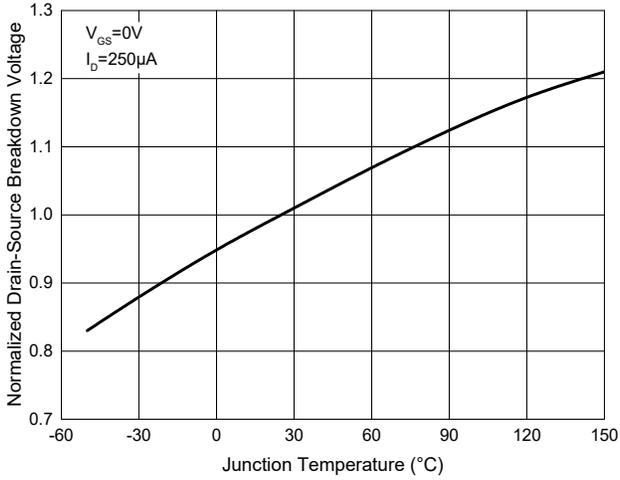


Fig. 8 - Safe Operation Area

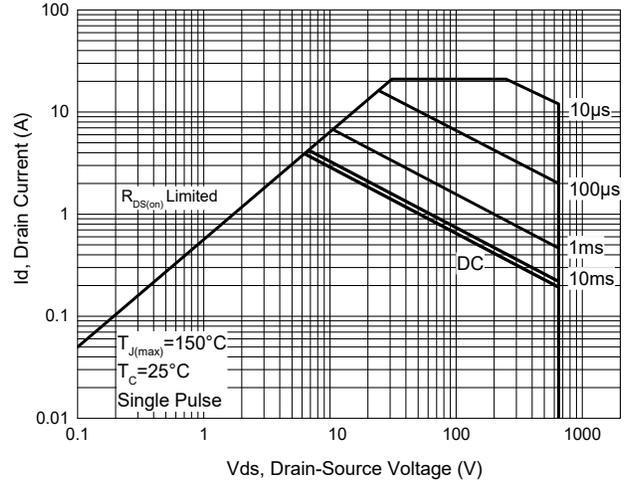
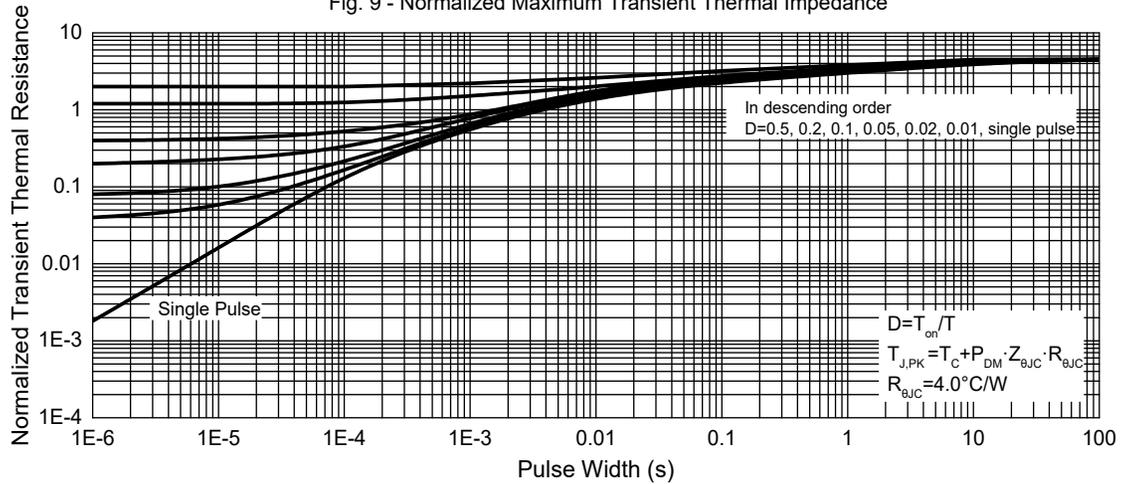


Fig. 9 - Normalized Maximum Transient Thermal Impedance



## Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 2.5Kpcs/Reel

Note : Adding "-HF" Suffix for Halogen Free, eg. Part Number-TP-HF

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